

## MX555ABB50M0000

## **Ultra-Low Jitter 50MHz LVDS XO**

### ClockWorks® FUSION

# **General Description**

The MX555ABB50M0000 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

### **Features**

- 50MHz LVDS
- Typical phase noise:
  - 121fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

## Absolute Maximum Ratings<sup>1</sup>

+4.6V
260°C
115°C
65°C to +125°C 200V
200V
2kV

# Operating Ratings<sup>2</sup>

Supply Voltage (VIN)	+2.375V to $+3.63V$
Ambient Temperature (TA)	$40^{\circ}$ C to $+85^{\circ}$ C
Junction Thermal Resistance	
LGA (T <sub>IC</sub> ) Still Air	58°C/W
` JC '	

## **Electrical Characteristics**

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with  $100\Omega$  between Q and /Q.<sup>3</sup>

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current			90	100	mA
F0	Center Frequency			50		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		156 121		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

#### **Notes:**

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- $3.\ Guaranteed\ after\ thermal\ equilibrium.$
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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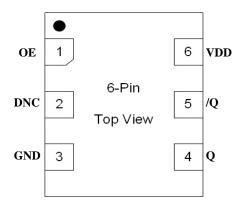
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# **Ordering Information**

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX555ABB50M0000	MX555A	BB0500	Tube	6-Pin 5mm x 3.2mm LGA
MX555ABB50M0000-TR	MX555A	BB0500	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

# **Pin Configuration**



# **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS Output Enable, disables output to tri-state, $0 = \text{Disabled}, 1 = \text{Enabled}, 50 \text{k}\Omega \text{ Pull-Up}$ (International Contents)	
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 50MHz
6	VDD	PWR		Power Supply

# **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A		
Moisture Resistance	MIL-STD-883, Method 1004		
Mechanical Shock	MIL-STD-883, Method 2002, Condition C		
Mechanical Vibration	MIL-STD-883, Method 2007, Condition B		
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)		
Hazardous Substance	Pb-Free / RoHS / Green Compliant		
Solderability	JESD22-B102-D Method 2 (Preconditioning E)		
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D		
Gross Leak	MIL-STD-883, Method 1014, Condition C		
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s		
MSL Level	Crystal - MSL-1, Package MSL-3		
Solvent Resistance	MIL-STD-202, Method 215		

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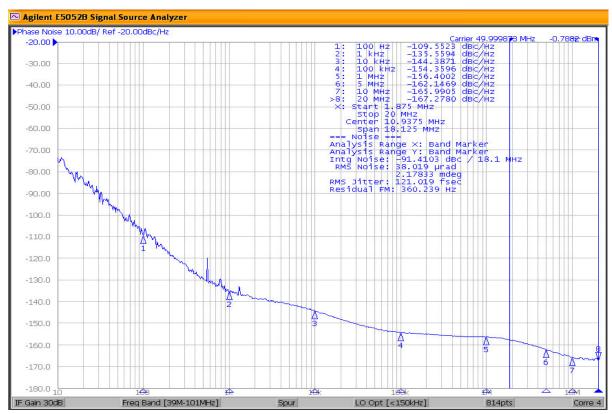


Figure 1. LVDS Output 50MHz 1.875MHz-20MHz 121fs

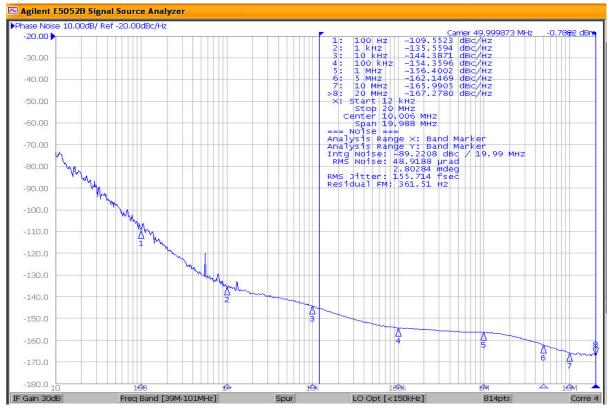
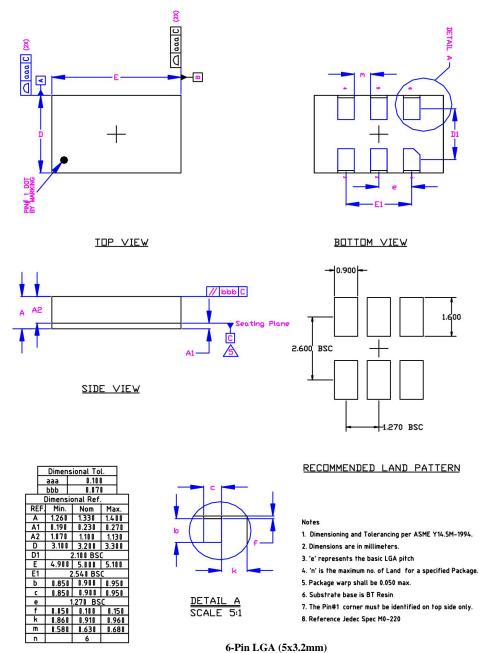


Figure 2. LVDS Output 50MHz 12kHz-20MHz 156fs

## Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



## Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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